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FAIRCHILD SEMICONDUCTOR

FDG315N N-Channel Logic Level PowerTrench[®] MOSFET

General Description

This N-Channel Logic Level MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench process that has been especially tailored to minimize on-state resistance and yet maintain superior switching performance.

These devices are well suited for low voltage and battery powered applications where low in-line power loss and fast switching are required.

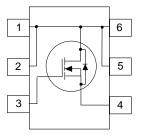
Applications

- DC/DC converter
- Load switch
- Power Management



Features

- 2 A, 30 V. $R_{DS(ON)} = 0.12 \ \Omega \ @ V_{GS} = 10 \ V$ $R_{DS(ON)} = 0.16 \ \Omega \ @ V_{GS} = 4.5 \ V.$
- Low gate charge (2.1nC typical).
- High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}.$
- Compact industry standard SC70-6 surface mount package.

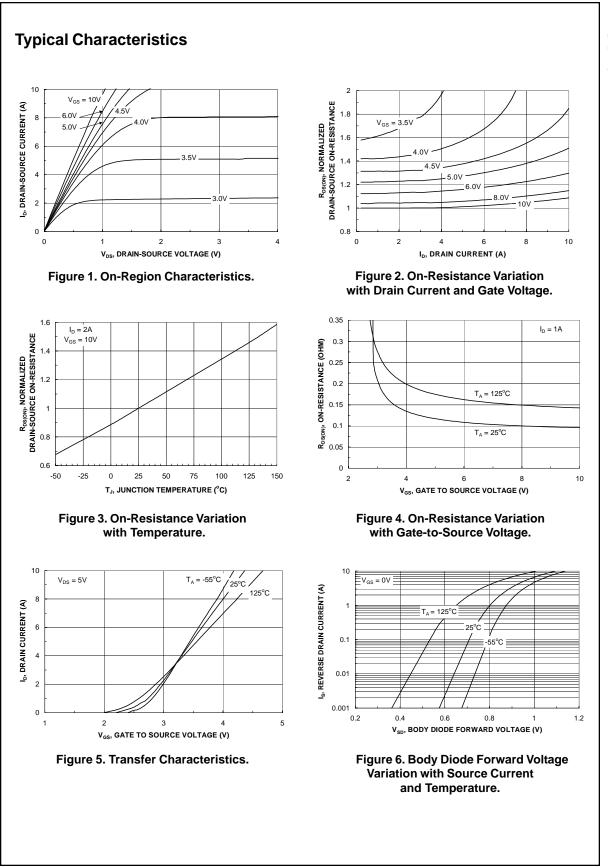


Absolute Maximum Ratings T_A = 25°C unless otherwise noted

Symbol	Parameter			Ratings	Units
V _{DSS}	Drain-Source Voltage			30	V
V _{GSS}	Gate-Source Voltage			±20	V
I _D	Drain Current	- Continuous	(Note 1a)	2	Α
		- Pulsed		6	
P _D	Power Dissipat	ion for Single Operation	(Note 1a)	0.75	W
			(Note 1b)	0.48	
T _J , T _{stq}	Operating and Storage Junction Temperature Range		ure Range	-55 to +150	°C
Therma R _{θJA}	Character Thermal Resist	ristics tance, Junction-to-Ambient	(Note 1b)	260	°C/W
Reja Package	Thermal Resist		ormation		°C/W
Reja Package	Thermal Resist	ance, Junction-to-Ambient		260 Tape Width	°C/W Quantity

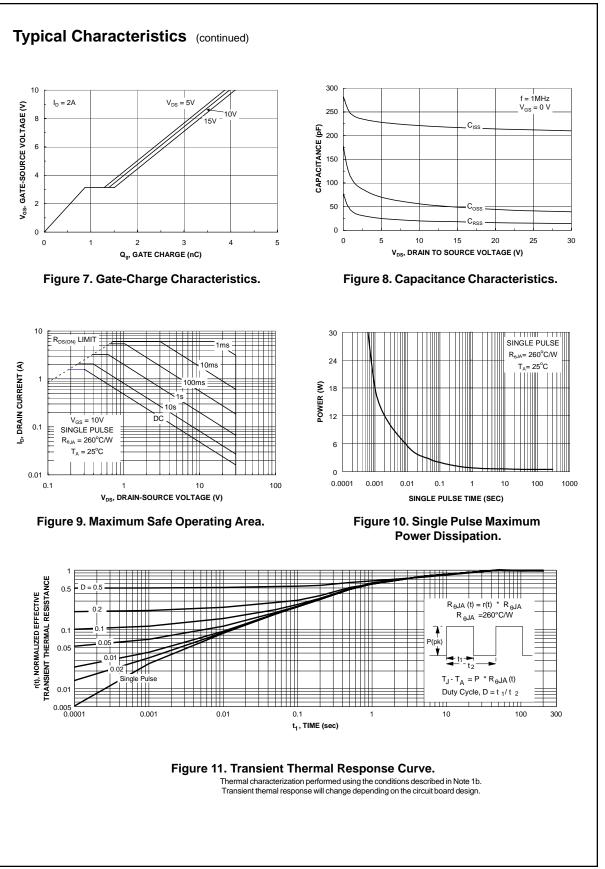
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	acteristics			•		
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 V, I_D = 250 \mu A$	30			V
<u>ΔBV_{DSS}</u> ΔTj	Breakdown Voltage Temperature Coefficient	I_D = 250 µA, Referenced to 25°C		26		mV/°C
IDSS	Zero Gate Voltage Drain Current	$V_{DS} = 24 \text{ V}, V_{GS} = 0 \text{ V}$			1	μΑ
GSS	Gate-Body Leakage Forward	V _{GS} = 16 V, V _{DS} = 0 V			100	nA
GSS	Gate-Body Leakage Reverse	V _{GS} = -16 V, V _{DS} = 0 V			-100	nA
On Char	acteristics (Note 2)	•				
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$	1	1.8	3	V
<u>ΔVgs(th)</u> ΔTj	Gate Threshold Voltage Temperature Coefficient	I_D = 250 µA, Referenced to 25°C		-4		mV/°0
RDS(on)	Static Drain-Source On-Resistance			0.100 0.140 0.130	0.12 0.20 0.16	Ω
D(on)	On-State Drain Current	$V_{GS} = 4.5 \text{ V}, V_{DS} = 5 \text{ V}$	3			Α
G _{FS}	Forward Transconductance	$V_{DS} = 5 V, I_D = 2 A$		5		S
Dvnamic	Characteristics	•				
Ciss	Input Capacitance	$V_{DS} = 15 V, V_{GS} = 0 V,$		220		pF
C _{oss}	Output Capacitance	f = 1.0 MHz		50		pF
Crss	Reverse Transfer Capacitance	1		20		pF
Switchin	g Characteristics (Note 2)					
d(on)	Turn-On Delay Time	$V_{DD} = 15 \text{ V}, I_D = 1 \text{ A},$		3	6	ns
-()	Turn-On Rise Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		11	22	ns
d(off)	Turn-Off Delay Time	-		7	14	ns
f	Turn-Off Fall Time	1		3	6	ns
ζ _a	Total Gate Charge	V _{DS} = 15 V, I _D = 2 A,		2.1	4	nC
Q _{gs}	Gate-Source Charge	$V_{GS} = 5 V$		0.8		nC
Q _{gd}	Gate-Drain Charge	1		0.7		nC
	ource Diode Characteristics	and Maximum Patings				
s	Maximum Continuous Drain-Source				0.42	A
V _{SD}	Drain-Source Diode Forward	$V_{GS} = 0 \ V, \ I_S = 0.42 \ A$ (Note 2)		0.7	1.2	V
of the drain pins a) 170°C/W w	Voltage of the junction-to-case and case-to-ambient therma s. R_{6UC} is guaranteed by design while R_{6CA} is determ hen mounted on a 1 in ² pad of 2oz copper. hen mounted on a minimum pad.	I resistance where the case thermal reference is defi ined by the user's board design.	ned as the so	l older mounti	I ing surface	<u> </u>

FDG315N



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	•	Rev. F1